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Tiny Integrated Temperature Sensor & Brushless DC Fan Controller with Overtemperature Alert

Features

- Integrated Temperature Sensing and Multi-speed Fan Control
- Built-in Overtemperature Alert (TOVER)
- Temperature-proportional Fan Speed Control for Acoustic Noise Reduction and Longer Fan Life
- Pulse Width Modulation (PWM) Output Drive for Cost and Power Savings
- · Solid-state Temperature Sensing
- ±1°C (typ.) Accuracy from 25°C to +70°C
- Operating Range: 2.8V 5.5V
- TC651 includes Automatic Fan Shutdown
- Low Operating Current: 50 μA (typ.)

Applications

- Thermal Protection For Personal Computers
- Digital Set-Top Boxes
- Notebook Computers
- · Data Communications
- · Power Supplies
- · Projectors

Related Literature

Application Note 771 (DS00771)

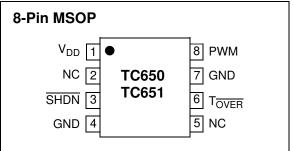
General Description

The TC650/TC651 are integrated temperature sensors and brushless DC fan speed controllers. The TC650/ TC651 measure the junction temperature and control the speed of the fan based on that temperature, making them especially suited for applications in modern electronic equipment.

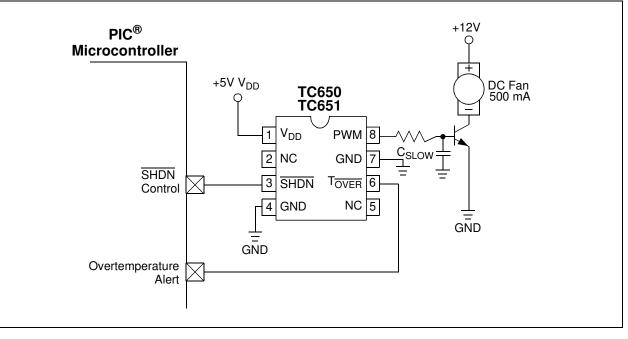
Temperature data is converted from the on-chip thermal sensing element and translated into a fractional fan speed from 40% to 100%. A temperature selection guide in the data sheet is used to choose the low and high temperature limits to control the fan. The TC650/TC651 also include a single trip point overtemperature alert ($T_{\overline{OVER}}$) that eliminates the need for additional temperature sensors. In addition, the TC651 features an auto fan shutdown function for additional power savings.

The TC650/TC651 are easy to use, require no software overhead and are, therefore, the ideal choice for implementing thermal management in a variety of systems.

Package Type



Typical Application Circuit



1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings†

Input Voltage (V _{DD} to GND)	.+6V
Output Voltage (OUT to GND)	6V
Voltage On Any Pin (GND – 0.3V) to (V_DD + 0.000 $\rm C$).3V)
Operating Temperature Range40°C to +12	25°C
Storage Temperature65°C to +15	50°C

† Notice: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions above those indicated in the operation sections of the specifications is not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability.

DC CHARACTERISTICS

Electrical Specifications: Unl	ess otherwise s	specified, V	_{DD} = 2.8V to	o 5.5V, <mark>S</mark>	HDN = \	$V_{\rm DD}, T_{\rm A} = -40^{\circ}{\rm C} \text{ to } +125^{\circ}{\rm C}.$
Parameters	Sym	Min	Тур	Max	Units	Conditions
Supply Voltage	V _{DD}	2.8	_	5.5	V	
Supply Current	I _{DD}	_	50	90	μA	PWM, T _{OVER} are open
SHDN Input						
SHDN Input High Threshold	V _{IH}	65			$%V_{DD}$	
SHDN Input Low Threshold	V _{IL}	_	_	15	$%V_{DD}$	
PWM Output						
PWM Output Low Voltage	V _{OL}	_	_	0.3	V	I _{SINK} = 1 mA
PWM Output High Voltage	V _{OH}	$V_{DD} - 0.5$	_	_	V	I _{SOURCE} = 5 mA
PWM Rise Time	t _R	_	10	_	μs	I _{OH} = 5 mA, 1 nF from PWM to GND
PWM Fall Time	t _F		10		μs	I _{OL} = 1 mA, 1 nF from PWM to GND
PWM Frequency	f _{OUT}	10	15		Hz	
Start-up Time	t _{STARTUP}	—	32/f _{OUT}	—	sec	V _{DD} Rises from GND or SHDN Released
Temperature Accuracy						
High Temperature Accuracy	T _{H ACC}	T _H – 3	Т _Н	T _H + 3	°C	Note 1
Temperature Range Accuracy	(T _{H –} T _L) _{ACC}	-1.0	_	+1.0	°C	$(T_H - T_L) \le 20^{\circ}C$
		-2.5	_	+2.5	°C	$(T_H - T_L) \ge 20^{\circ}C$
Auto-shutdown Hysteresis	T _{HYST}	_	(T _H -T _L)/5		°C	TC651 Only
T _{OVER} Output						
T _{OVER} Output High Voltage	V _{HIGH}	$V_{DD} - 0.5$	_	_	V	I _{SOURCE} = 1.2 mA
T _{OVER} Output Low Voltage	V _{LOW}	_	_	0.4	V	I _{SINK} = 2.5 mA
Absolute Accuracy	TOVER ACC	_	T _H + 10	_	°C	At Trip Point
Trip Point Hysteresis	TOVER HYST	_	5	_	°C	

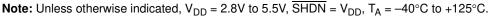
Note 1: Transition from 90% to 100% Duty Cycle.

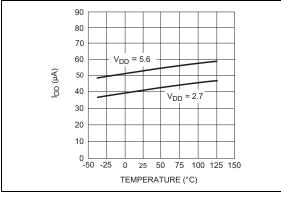
TEMPERATURE CHARACTERISTICS

Electrical Specifications: Unless otherwise noted, $V_{DD} = 2.8V$ to 5.5V, $\overline{SHDN} = V_{DD}$, $T_A = -40^{\circ}C$ to $+125^{\circ}C$.							
Parameters	Sym	Min	Тур	Max	Units	Conditions	
Temperature Ranges							
Specified Temperature Range	T _A	-40		+125	°C		
Maximum Junction Temperature	ТJ	_		+150	°C		
Storage Temperature Range	T _A	-65		+150	°C		
Package Thermal Resistances							
Thermal Resistance, 8L-MSOP	θ_{JA}	_	206.3		°C/W		

2.0 TYPICAL PERFORMANCE CURVES

Note: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.







IDD vs. Temperature.

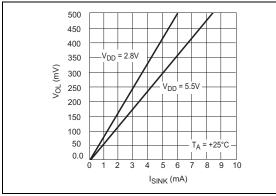
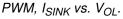


FIGURE 2-2:



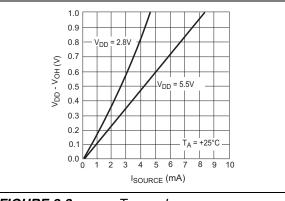
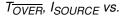


FIGURE 2-3: $(V_{DD} - V_{OH}).$



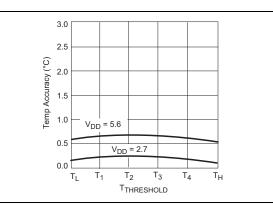


FIGURE 2-4: V_{TH}.

Temperature Accuracy vs.



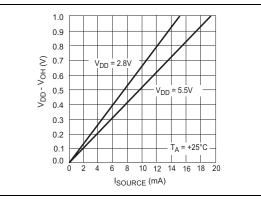


FIGURE 2-5: $(V_{DD} - V_{OH}).$

PWM, I_{SOURCE} vs.

3.0 PIN DESCRIPTION

The descriptions of the pins are listed in Table 3-1.

TABLE 3-1: PIN FUNCTION TABLE

Pin No.	Symbol	Description
1	V _{DD}	Power Supply Input
2	NC	No Internal Connect
3	SHDN	Fan Shutdown, Active-low Input 1 = Fan in normal operation 0 = Fan in shutdown
4	GND	Ground
5	NC	No Connect
6	T _{OVER}	Overtemperature Alert, Active-low Output 1 = Overtemperature condition does not exist 0 = The device is in the overtemperature condition. The fan is driven at 100%. Potential exists for system over-heating
7	GND	Ground
8	PWM	PWM Fan Drive Output

3.1 Power Supply Input

May be independent of fan power supply.

3.2 Fan Shutdown, Active-low Input

During Shutdown mode, the chip still monitors temperature. $T_{\overline{\text{OVER}}}$ is low if temperature rises above factory set point.

3.3 Ground

Ground return for all TC650/TC651 functions.

3.4 Overtemperature Alert

Active-low output.

3.5 **PWM Fan Drive Output**

Pulse width modulated rail-to-rail logic output. Nominal frequency is 15 Hz.

4.0 DETAILED DESCRIPTION

The TC650/TC651 acquire and convert their junction temperature (T_{.1}) information from an on-chip, solidstate sensor with a typical accuracy of ±1°C. The temperature data is digitally stored in an internal register. The register is compared with pre-defined threshold values. The six threshold values are equally distributed over a pre-defined range of temperatures (see Table 4-1). The TC650/TC651 control the speed of a DC brushless fan using a fractional speed-control scheme. The output stage requires only a 2N2222-type, small-signal BJT for fans up to 300 mA. For larger current fans (up to 1 amp), a logic-level N-channel MOSFET may be used. In addition to controlling the speed of the fan, the TC650/TC651 include an on-chip overtemperature alarm (TOVER) that gives a low signal when the temperature of the chip exceeds T_H by 10°C (typical). This feature eliminates the need for a separate temperature sensor for overtemperature monitoring. Figure 4-1 shows the block diagram of the device.

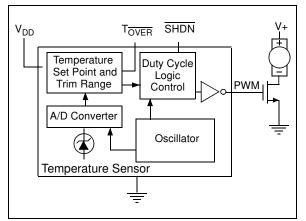


FIGURE 4-1: Functional Block Diagram.

4.1 PWM Output

The PWM pin is designed to drive a low-cost transistor or MOSFET as the low-side, power-switching element in the system. This output has an asymmetric complementary drive and is optimized for driving NPN transistors or N-channel MOSFETs. Since the system relies on PWM rather than linear power control, the dissipation in the power switch is kept to a minimum. Generally, very small devices (TO-92 or SOT packages) will suffice. The frequency of the PWM is about 15 Hz. The PWM is also the time base for the Start-up Timer (see **Section 4.2 "Start-Up Timer"**). The PWM duty cycle has a range of 40% to 100% for the TC650 and 50% to 100% for the TC651.

4.2 Start-Up Timer

To ensure reliable fan start-up, the Start-up Timer turns PWM high for about 2 seconds whenever the fan is started from the off state. This occurs at power-up and when coming out of Shutdown mode.

4.3 Overtemperature Alert (T_{OVER})

This pin goes low when the T_H set point is exceeded by 10°C (typical). This indicates that the fan is at maximum drive and the potential exists for system overheating; either heat dissipation in the system has gone beyond the cooling system's design limits or some fault exists (such as fan bearing failure or an airflow obstruction). This output may be treated as a "System Overheat" warning and be used to either trigger system shutdown or bring other fans in the system to full speed. The fan will continue to run at full speed while TOVER is asserted. Built-in hysteresis prevents $T_{\overline{OVER}}$ from "chattering" when the measured temperature is at or near the T_H + 10°C trip point. As temperature falls through the T_H + 10°C trip point, hysteresis maintains the TOVER output low until the measured temperature is 5°C above the trip point setting.

4.4 Shutdown (SHDN)

The fan can be unconditionally shut down by pulling the SHDN pin low. During shutdown, the PWM output is low; ideal for notebook computers and other portable applications where you need to change batteries and must not have the fan running at that time. Thermal monitoring and $T_{\overline{OVER}}$ are still in operation during shutdown. I_{DD} shutdown current is around 50 µA.

4.5 Auto-shutdown Mode

The TC651 features auto-shutdown. When the temperature is below the factory set point at minimum speed (T_L), PWM is low and the fan is automatically shut off (Auto-shutdown mode). This feature is ideal for notebook computers and other portable equipment that need to conserve as much battery power as possible and, thus, run a fan when it is only absolutely needed. The TC651 will continue to be active in order to monitor temperature for $T_{\overline{OVER}}$. The TC651 exits Auto-shutdown mode when the temperature rises above the factory set point (T_1).

4.6 Temperature Selection Guide (Minimum Fan Speed/Full Speed)

There are two temperature thresholds that determine the characteristics of the device. The minimum fan speed temperature (T_L) and the full fan speed temperature (T_H). Depending on the TC65X device selected, when the temperature is below the T_L trip point, the PWM output will perform a different operation. For the TC650, the PWM will be driven at the minimum PWM frequency, while the TC651 will shut down the PWM (PWM = L).

 T_L and T_H can be selected in 5°C increments. T_L can range from 25°C to 35°C. T_H can range from 35°C to 55°C and must be 10°C (or more) than the specified T_I .

The five temperature regions defined by the six thresholds are defined in the TC650/TC651 by means of factory trimming. Once a T_L and T_H are set, the T_1-T_4 thresholds are automatically equally spaced between T_L and T_H . Table 4-1 shows these 5 regions and what the corresponding PWM duty cycle is.

TABLE 4-1:TEMPERATURE RANGEDEFINITION

Tomporatura	PWM Duty Cycle						
Temperature (T = T _J) (Note 1)	TC650 (Minimum Speed mode)	TC651 (Auto-shutdown mode)					
T < T _L	40%	Off					
$T_L < = T < T_1$	50%	50%					
$T_1 < = T < T_2$	60%	60%					
$T_2 < = T < T_3$	70%	70%					
$T_3 < = T < T_4$	80%	80%					
$T_4 < = T < T_H$	90%	90%					
$T_{\rm H} < = T < T_{\rm OV}$	100%	100%					
$T_{OV} < = T$	100% with Overtemperature Alert $(T_{\overline{OVER}} = L)$						

Note 1: The temperature regions defined by the six temperature thresholds are predefined in the TC650/TC651 by means of factory trimming. Once a T_L and T_H are programmed, the $T_1 - T_4$ thresholds are automatically equally spaced between T_L and T_H . Table 4-2 shows the device codes that specify the $T_{\rm H}$ and $T_{\rm L}$ temperature thresholds. The following examples are given to assist in understanding the device-ordering nomenclature.

- Example 1: Suppose you wanted the fan to run at 40% speed at 25°C or less and go to fullspeed at 45°C. You would order the part number TC650AEVUA.
- Example 2: Suppose you wanted the fan to turn on at 30°C and go to full speed at 45°C. You would order the part number TC651BEVUA.

TABLE 4-2: DEVICE CODES FOR TEMPERATURE THRESHOLDS

Temp. Threshold Difference	TL	т _н	Threshold Limits Code
10°C	25	35	AC ⁽¹⁾
	30	40	BD ⁽²⁾
	35	45	CE ⁽²⁾
15°C	25	40	AD ⁽²⁾
	30	45	BE ⁽¹⁾
	35	50	CF ⁽²⁾
20°C	25	45	AE ⁽¹⁾
	30	50	BF ⁽²⁾
	35	55	CG ⁽¹⁾
30°C	25	55	AG ⁽¹⁾

Note 1: This temperature threshold option is available for ordering.

^{2:} This is a custom temperature threshold option. Please contact the factory for more information.

5.0 TYPICAL APPLICATIONS

5.1 Reducing Switching Noise

For fans consuming more than 300 mA, a slowdown capacitor (C_{SLOW}) is recommended for reducing switching PWM induced noise (see Figure 5-1). The value of this capacitor should be 4.7 μ F to 47 μ F, depending on the fan current consumption.

See Application Note 771, "Suppressing Acoustic Noise in PWM Fan Speed Control Systems" (DS00771), for more information.

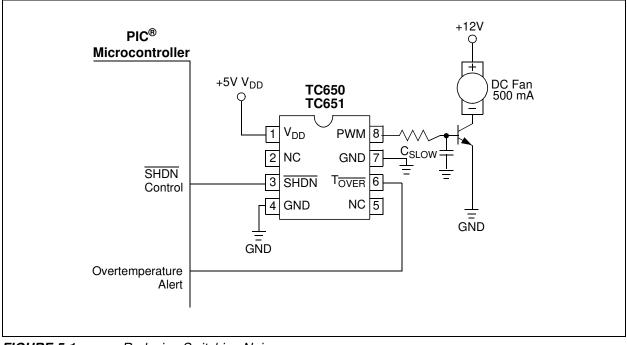
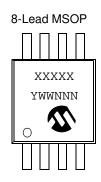


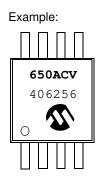
FIGURE 5-1:

Reducing Switching Noise.

6.0 PACKAGING INFORMATION

6.1 Package Marking Information

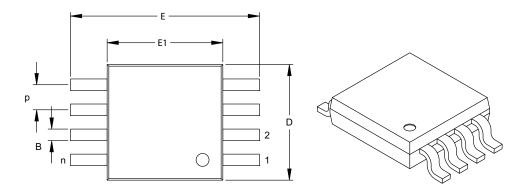


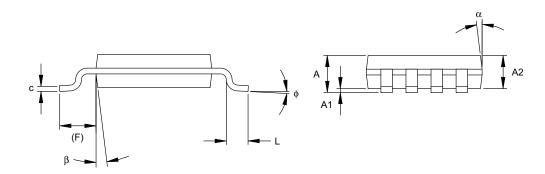


Legend	: XXX Y YY WW NNN @3 *	Customer-specific information Year code (last digit of calendar year) Year code (last 2 digits of calendar year) Week code (week of January 1 is week '01') Alphanumeric traceability code Pb-free JEDEC designator for Matte Tin (Sn) This package is Pb-free. The Pb-free JEDEC designator ((e3)) can be found on the outer packaging for this package.
Note:	be carrie	nt the full Microchip part number cannot be marked on one line, it will d over to the next line, thus limiting the number of available s for customer-specific information.

8-Lead Plastic Micro Small Outline Package (MS) (MSOP)

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging





	Units		INCHES		MILLIMETERS*			
Dimension Lim	its	MIN	NOM	MAX	MIN	NOM	MAX	
Number of Pins	n		8			8		
Pitch	р		.026 BSC			0.65 BSC		
Overall Height	A	-	-	.043	-	-	1.10	
Molded Package Thickness	A2	.030	.033	.037	0.75	0.85	0.95	
Standoff	A1	.000	-	.006	0.00	-	0.15	
Overall Width	E	.193 TYP.			4.90 BSC			
Molded Package Width	E1		.118 BSC			3.00 BSC		
Overall Length	D		.118 BSC		3.00 BSC			
Foot Length	L	.016	.024	.031	0.40	0.60	0.80	
Footprint (Reference)	F		.037 REF		0.95 REF			
Foot Angle	¢	0°	-	8°	0°	-	8°	
Lead Thickness	С	.003	.006	.009	0.08	-	0.23	
Lead Width	В	.009	.012	.016	0.22	-	0.40	
Mold Draft Angle Top	α	5 ⁵ °	-	15°	5°	-	15°	
Mold Draft Angle Bottom	β	5 ⁵ °		15°	5°	-	15°	

*Controlling Parameter

Notes:

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.

JEDEC Equivalent: MO-187

Drawing No. C04-111

6.2 Product Tape and Reel Specifications

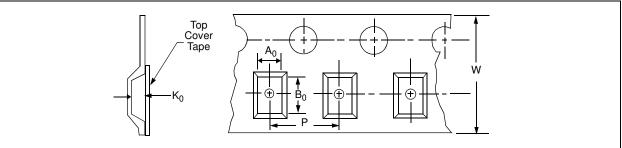
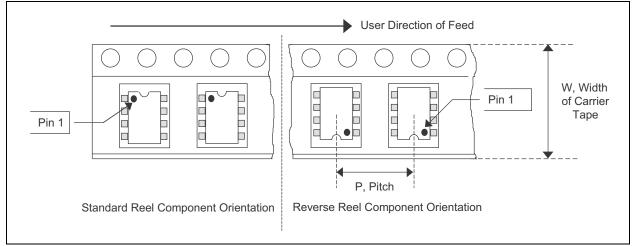


FIGURE 6-1: EMBOSSED CARRIER DIMENSIONS

TABLE 1: CARRIER TAPE/CAVITY DIMENSIONS

Case	Package	Carrier Cavity Dimensions Dimensions		Output Quantity	Reel Diameter in				
Outline	Туре		W mm	P mm	A0 mm	B0 mm	K0 mm	Units	mm
MS	MSOP	8L	12	8	5.3	3.6	1.4	2500	330

FIGURE 1: MSOP DEVICES



7.0 REVISION HISTORY

Revision D (December 2012)

Added a note to the package outline drawing.

NOTES:

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

PART NO.	<u>xx</u>	X	<u>xx</u>		Exa	mples:	
Device	l Femperature Tem Threshold R Limit	perature F ange	Package		a) b)	TC650ACVUA:	Temp Sensor $T_L = 25$, $T_H = 35$ Temp Sensor $T_1 = 25$, $T_H = 35$
Device:	TC651: Temp Se	perature Aler ensor & Brush	t (minimum sp	beed) Controller /	c) d)	TC650AEVUA: TC651AGVUA:	Tape and Reel Temp Sensor $T_L = 25$, $T_H = 45$ Temp Sensor $T_L = 25$, $T_H = 55$
Temperature Threshold Limit:	Temperature Difference	T _L ^(1,2)	T _H ^(1,3)	Threshold Limit Code	e) f)	TC650BEVUA: TC651CGVUA:	Temp Sensor T _L = 30, T _H = 45 Temp Sensor
	10°C	25 30 35	35 40 45	AC BD CE	g)	TC650CGVUATR:	$T_L = 35$, $T_H = 55$ Temp Sensor $T_L = 35$, $T_H = 55$ Tape and Reel
	15°C	25 30 35	40 45 50	AD BE CF			
	20°C	25 30 35	45 50 55	AE BF CG			
	30°C	25	55	AG			
2. TL can range from	e selected in 5°C incre m 25°C to 35°C. m 35°C to 55°C and n		st 10°C highe	r than T _L .			
Temperature Range	$V = -40^{\circ}C \text{ to } + 7$	125°C (Exten	ded)				
Package:	UA = Plastic M UATR = Plastic M (Tape an	licro Small O	utline (MSOP) utline (MSOP)				

Sales and Support

Data Sheets

Products supported by a preliminary Data Sheet may have an errata sheet describing minor operational differences and recommended workarounds. To determine if an errata sheet exists for a particular device, please contact one of the following:

1. Your local Microchip sales office

2. The Microchip Worldwide Site (www.microchip.com)

Please specify which device, revision of silicon and Data Sheet (include Literature #) you are using.

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